

REVISIONS

LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
E	Remove vendors CAGE 18234, 27014 and 34335. Change to Military drawing format. Add LCC package.	87-06-18	N. A. Hauck
F	Update to reflect latest changes in format and requirements. Editorial changes throughout. --les	02-12-09	Raymond Monnin
G	Correct marking paragraph. Editorial changes throughout. - gap	05-12-06	Raymond Monnin

CURRENT CAGE CODE 67268

THE ORIGINAL FIRST PAGE OF THIS DRAWING HAS BEEN REPLACED.

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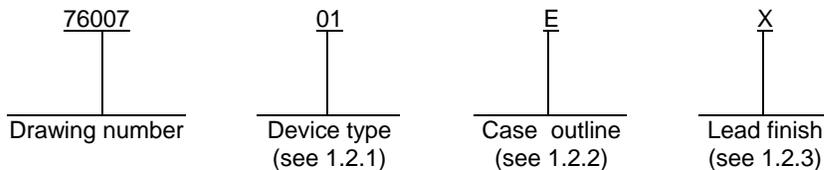
REV STATUS	REV	G	G	G	G	G	G	G	G	G	G	G				
OF SHEETS	SHEET	1	2	3	4	5	6	7	8	9	10					

PMIC N/A	PREPARED BY Joseph A. Kerby	<b>DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216 <a href="http://www.dsccl.dla.mil">http://www.dsccl.dla.mil</a></b>													
<b>STANDARD MICROCIRCUIT DRAWING</b>  THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS  AND AGENCIES OF THE DEPARTMENT OF DEFENSE  AMSC N/A	CHECKED BY D. A. DiCenzo														
	APPROVED BY N. A. Hauck	MICROCIRCUIT, DIGITAL, LOW-POWER SCHOTTKY TTL, DECODERS, MONOLITHIC SILICON													
	DRAWING APPROVAL DATE 76-03-19														
	REVISION LEVEL G	SIZE A	CAGE CODE <b>14933</b>	<b>76007</b>											
		SHEET 1 OF 10													

1. SCOPE

1.1 Scope. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 Device type(s). The device type(s) identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	54LS139	2 to 4 line decoder

1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
E	GDIP1-T16 or CDIP2-T16	16	dual-in-line
F	GDFP2-F16 or CDFP3-F16	16	flat
2	CQCC1-N20	20	square chip carrier

1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.

1.3 Absolute maximum ratings.

Supply voltage .....	-0.5 V dc to +7.0 V dc
Input voltage range .....	-1.5 V dc at -18 mA to +5.5 V dc
Storage temperature range.....	-65°C to +150°C
Maximum power dissipation ( $P_D$ ) <sup>1/</sup> .....	61mW
Lead temperature (soldering, 10 seconds) .....	+300°C
Thermal resistance, junction-to-case ( $\theta_{JC}$ ) .....	See MIL-STD-1835
Junction temperature ( $T_J$ ) .....	+175°C

1.4 Recommended operating conditions.

Supply voltage range ( $V_{CC}$ ) .....	4.5 V dc minimum to 5.5 V dc maximum
Minimum high level input voltage ( $V_{IH}$ ) .....	2.0 V dc
Maximum low level input voltage ( $V_{IL}$ ) .....	0.7 V dc
Case operating temperature range ( $T_C$ ) .....	-55°C to +125°C

<sup>1/</sup> Must withstand the added  $P_D$  due to short circuit test (e.g.,  $I_{OS}$ ).

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2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-38535 -- Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Method Standard Microcircuits.  
 MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

HANDBOOKS

DEPARTMENT OF DEFENSE

MIL-HDBK-103 -- List of Standard Microcircuit Drawings.  
 MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Truth table. The truth tables shall be as specified on figure 2.

3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C ≤ T <sub>C</sub> ≤ +125°C unless otherwise specified		Group A subgroups	Device type	Limits		Unit	
						Min	Max		
High level output voltage	V <sub>OH</sub>	V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -400 μA V <sub>IL</sub> = 0.7 V, V <sub>IH</sub> = 2.0 V		1, 2, 3	All	2.5		V	
Low level output voltage	V <sub>OL</sub>	V <sub>CC</sub> = 4.5 V, I <sub>OL</sub> = 4 mA V <sub>IL</sub> = 0.7 V, V <sub>IH</sub> = 2.0 V		1, 2, 3	All		0.4	V	
Input clamp voltage	V <sub>IC</sub>	V <sub>CC</sub> = 4.5 V, I <sub>IN</sub> = -18 mA, T <sub>C</sub> = +25°C		1	All		-1.5	V	
High level input current	I <sub>IH1</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IH</sub> = 2.7 V		1, 2, 3	All		20	μA	
	I <sub>IH2</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IH</sub> = 5.5 V		1, 2, 3	All		100	μA	
Low level input current	I <sub>IL</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IL</sub> = 0.4 V		1, 2, 3	All		-400	μA	
Short-circuit output current	I <sub>OS</sub>	V <sub>CC</sub> = 5.5 V, V <sub>OUT</sub> = 0.0 V <u>1/</u>		1, 2, 3	All	-6	-130	mA	
Supply current	I <sub>CC</sub>	V <sub>CC</sub> = 5.5 V		1, 2, 3	All		11	mA	
Functional tests		See 4.3.1c		7	All				
Propagation delay time, high-to-low level, <u>2/</u> select to Y (two levels of delay)	t <sub>PHL1</sub>	V <sub>CC</sub> = 5.0 V, R <sub>L</sub> = 2 kΩ ±5%	C <sub>L</sub> = 15 pF ±10%	9	All		33	ns	
				10, 11	All		46	ns	
			C <sub>L</sub> = 50 pF ±10%	9	All		38	ns	
				10, 11	All		53	ns	
Propagation delay time, low-to-high level, <u>2/</u> select to Y (two levels of delay)	t <sub>PLH1</sub>		V <sub>CC</sub> = 5.0 V, R <sub>L</sub> = 2 kΩ ±5%	C <sub>L</sub> = 15 pF ±10%	9	All		20	ns
					10, 11	All		28	ns
				C <sub>L</sub> = 50 pF ±10%	9	All		25	ns
					10, 11	All		35	ns
Propagation delay time, high-to-low level, <u>2/</u> select to Y (three levels of delay)	t <sub>PHL2</sub>	V <sub>CC</sub> = 5.0 V, R <sub>L</sub> = 2 kΩ ±5%		C <sub>L</sub> = 15 pF ±10%	9	All		38	ns
					10, 11	All		53	ns
				C <sub>L</sub> = 50 pF ±10%	9	All		43	ns
					10, 11	All		60	ns
Propagation delay time, low-to-high level, <u>2/</u> select to Y (three levels of delay)	t <sub>PLH2</sub>		V <sub>CC</sub> = 5.0 V, R <sub>L</sub> = 2 kΩ ±5%	C <sub>L</sub> = 15 pF ±10%	9	All		29	ns
					10, 11	All		41	ns
				C <sub>L</sub> = 50 pF ±10%	9	All		34	ns
					10, 11	All		48	ns

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C ≤ T <sub>C</sub> ≤ +125°C unless otherwise specified		Group A subgroups	Device type	Limits		Unit
						Min	Max	
Propagation delay time, high-to-low level, <u>2/</u> enable to Y (two levels of delay)	t <sub>PHL3</sub>	V <sub>CC</sub> = 5.0 V, R <sub>L</sub> = 2 kΩ ±5%	C <sub>L</sub> = 15 pF ±10%	9	All		32	ns
				10, 11	All		45	ns
			C <sub>L</sub> = 50 pF ±10%	9	All		37	ns
				10, 11	All		52	ns
Propagation delay time, low-to-high level, <u>2/</u> enable to Y (two levels of delay)	t <sub>PLH3</sub>		C <sub>L</sub> = 15 pF ±10%	9	All		24	ns
				10, 11	All		34	ns
			C <sub>L</sub> = 50 pF ±10%	9	All		29	ns
				10, 11	All		41	ns

1/ Not more than one output should be shorted at a time, and the duration of the short-circuit condition should not exceed one second.

2/ Propagation delay time testing may be performed using either C<sub>L</sub> = 15 pF or C<sub>L</sub> = 50 pF. However, the manufacturer must certify and guarantee that the microcircuits meet the switching test limits specified for a 50 pF load.

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Device types	01	01
Case outlines	E, F	2
Terminal number	Terminal symbols	Terminal symbols
1	$1\bar{G}$	N/C
2	1A	$1\bar{G}$
3	1B	1A
4	1Y0	1B
5	1Y1	1Y0
6	1Y2	N/C
7	1Y3	1Y1
8	GND	1Y2
9	2Y3	1Y3
10	2Y2	GND
11	2Y1	N/C
12	2Y0	2Y3
13	2B	2Y2
14	2A	2Y1
15	$2\bar{G}$	2Y0
16	$V_{CC}$	N/C
17	---	2B
18	---	2A
19	---	$2\bar{G}$
20	---	$V_{CC}$

FIGURE 1. Terminal connections.

Inputs			Outputs			
Enable $\bar{G}$	Select		Y0	Y1	Y2	Y3
	B	A				
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	L	H	H	L	H	H
L	H	L	H	H	L	H
L	H	H	H	H	H	L

H = High level  
L = Low level  
X = Irrelevant

FIGURE 2. Truth table.

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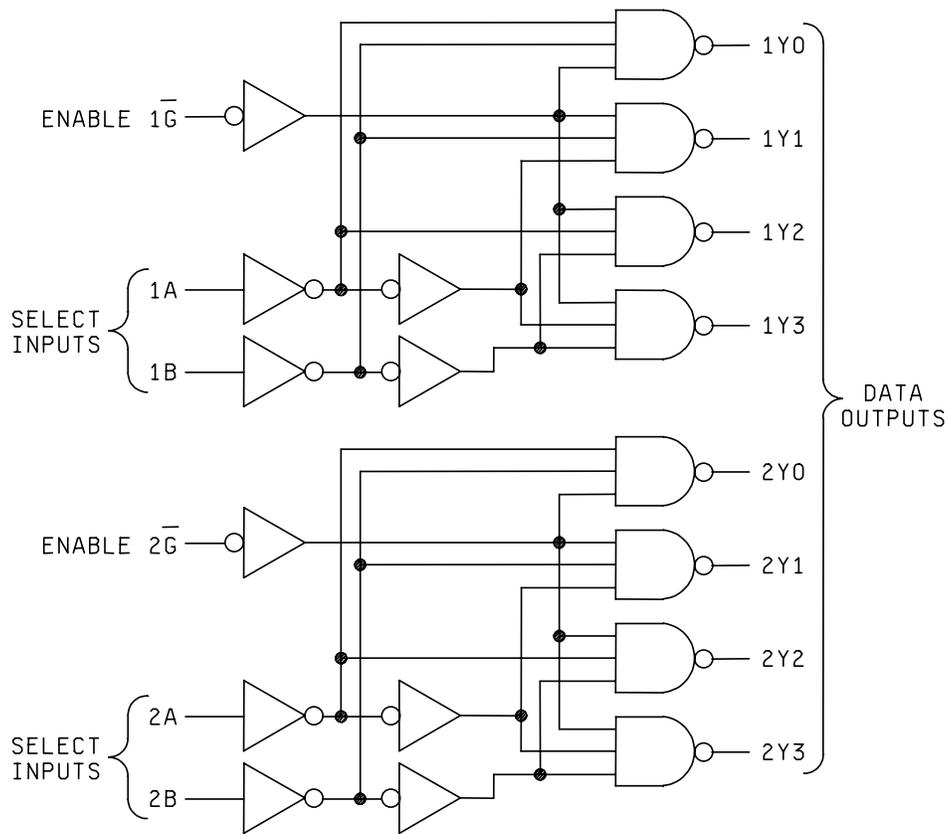


FIGURE 3. Logic diagram.

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3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked.

3.5.1 Certification/compliance mark. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.

3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DSCC-VA shall be required in accordance with MIL-PRF-38535, appendix A.

3.9 Verification and review. DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

#### 4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.

(2)  $T_A = +125^\circ\text{C}$ , minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

##### 4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 4, 5, 6, and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.

c. Subgroup 7 shall include verification of the truth table.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*, 2, 3, 9
Group A test requirements (method 5005)	1, 2, 3, 7, 9, 10**, 11**
Group C and D end-point electrical parameters (method 5005)	1, 2, 3

\* PDA applies to subgroup 1.

\*\* Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
  - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
  - (2)  $T_A = +125^\circ\text{C}$ , minimum.
  - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

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6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.4 Record of users. Military and industrial users shall inform Defense Supply Center Columbus when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.5 Comments. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0674.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 05-12-06

Approved sources of supply for SMD 76007 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535.

Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>	Reference military specification PIN
7600701EA	01295 58625 <u>3/</u> <u>3/</u>	SNJ54LS139AJ SL54LS139/BEA 54LS139/BEAJC 54LS139DMQB	M38510/30702BEA
7600701FA	01295 58625 <u>3/</u> <u>3/</u>	SNJ54LS139AW SL54LS139/BFA 54LS139FMQB 54LS139/BFAJC	M38510/30702BFA
76007012A	01295 <u>3/</u> <u>3/</u>	SNJ54LS139AFK 54LS139LMQB 54LS139/B2AJC	M38510/30702B2A

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 3/ Not available from an approved source of supply.

Vendor CAGE  
number

01295

58625

Vendor name  
and address

Texas Instruments, Inc.  
Semiconductor Group  
8505 Forest Ln.  
PO Box 660199  
Dallas, Tx 75243

POC U.S. Highway 75 South  
P.O. Box 84, M/S 853  
Sherman, TX 75090-9493

Lansdale Semiconductor Inc.  
2929 South 48th St.  
Tempe, AZ 85282

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